

New Product

N-Channel 200-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}\left(\Omega\right)$	I _D (A)		
200	0.24 at V _{GS} = 10 V	2.8		
	0.26 at V _{GS} = 6 V	2.7		

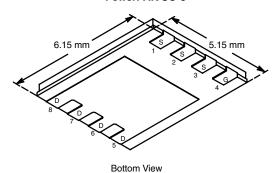
FEATURES

- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07-mm Profile
- · PWM Optimized For Fast Switching



COMPLIANT

PowerPAK SO-8

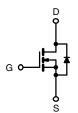


Ordering Information: Si7464DP-T1

Si7464DP-T1-E3 (Lead (Pb)-free)

APPLICATIONS

Primary Side Switch



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A	$= 25 ^{\circ}\text{C}$, unles	ss otherwise n	oted		
Parameter	Symbol	10 secs	Steady State	Unit	
Drain-Source Voltage		V_{DS}	200		V
Gate-Source Voltage		V_{GS}	± 20		
Continuous Drain Current /T 150 °C\a	T _A = 25 °C	I _D	2.8	1.8	
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 70 °C		2.2	1.5	
Continuous Source Current		I _S	3.5	1.5	Α
Pulsed Drain Current		I _{DM}	8		
Avalanche Current ^b		I _{AS}	3		
Single Avalanche Energy ^b		E _{AS}	0.45		mJ
Maximum Dawar Dissipations	T _A = 25 °C	P _D	4.2	1.8	W
Maximum Power Dissipation ^a	T _A = 70 °C		2.6	1.1	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	– 55 to 150		°C
Soldering Recommendations (Peak Temperature) ^{c,d}			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Manianum lumation to Ambienta	t ≤ 10 sec	R _{thJA}	25	30	°C/W	
Maximum Junction-to-Ambient ^a	Steady State		60	70		
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}	2.9	3.5		

Notes

Notes
a. Surface Mounted on 1" x 1" FR4 Board.
b. Guaranteed by design, not subject to production testing.
c. See Solder Profile (http://www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
d. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

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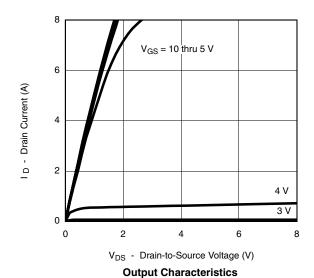


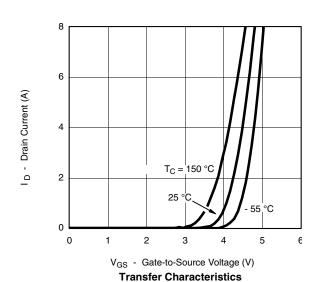
Parameter	Symbol	mbol Test Condition		Тур	Max	Unit	
Static	1 - 1						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 200 \text{ V}, V_{GS} = 0 \text{ V}$			1		
		V_{DS} = 200 V, V_{GS} = 0 V, T_{J} = 55 °C			5	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	8			Α	
	_	$V_{GS} = 10 \text{ V}, I_D = 2.8 \text{ A}$		0.195	0.24	-	
Drain-Source On-State Resistance ^a	r _{DS(on)}	$V_{GS} = 6 \text{ V}, I_D = 2.7 \text{ A}$		0.210	0.26	Ω	
Forward Transconductance ^a	g _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 2.8 \text{ A}$		8		S	
Diode Forward Voltage ^a	V _{SD}	$I_S = 3.5 \text{ A}, V_{GS} = 0 \text{ V}$		0.8	1.2	V	
Dynamic ^b	<u> </u>		1	- I			
Total Gate Charge	Q _g			12	18	nC	
Gate-Source Charge	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 2.8 \text{ A}$		2.5			
Gate-Drain Charge	Q _{gd}			3.8		1	
Gate Resistance	R_g			2.5		Ω	
Turn-On Delay Time	t _{d(on)}			10	15		
Rise Time	t _r	V_{DD} = 100 V, R_L = 100 Ω		12	20	ns	
Turn-Off Delay Time	t _{d(off)}	$I_D\cong$ 1 A, V_{GEN} = 10 V, R_G = 6 Ω		15	25		
Fall Time	t _f			15	25		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3.5 A, di/dt = 100 A/μs		60	90		

- Notes a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless noted

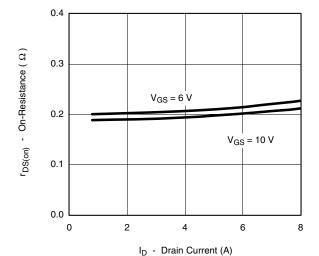




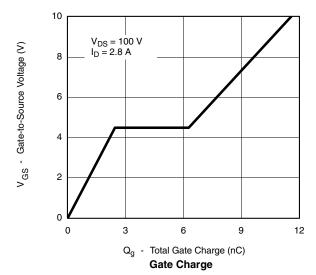


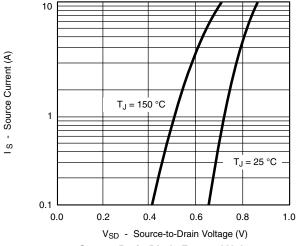
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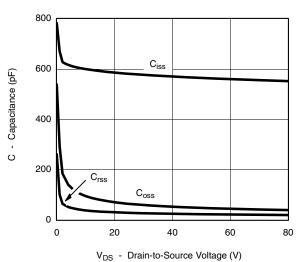


On-Resistance vs. Drain Current

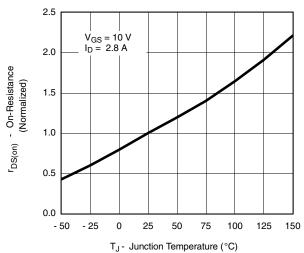




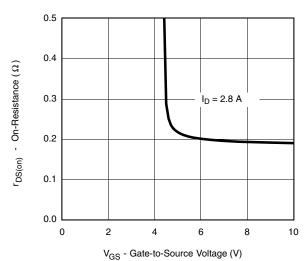
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature



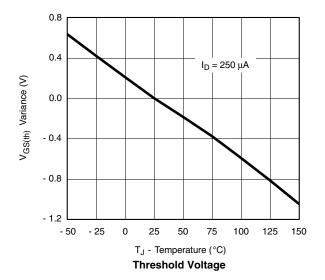
On-Resistance vs. Gate-to-Source Voltage

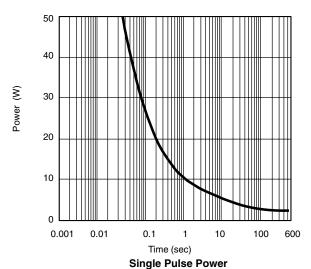
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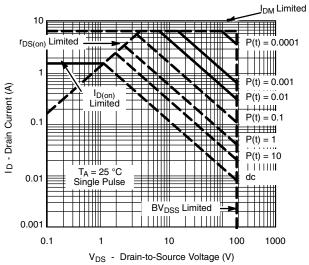


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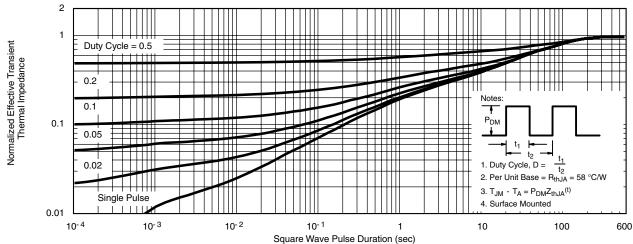




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Safe Operating Area

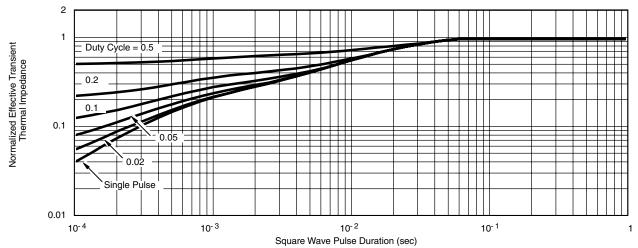


Normalized Thermal Transient Impedance, Junction-to-Ambient

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TYPICAL CHARACTERISTICS 25 °C, unless noted



Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72052.



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